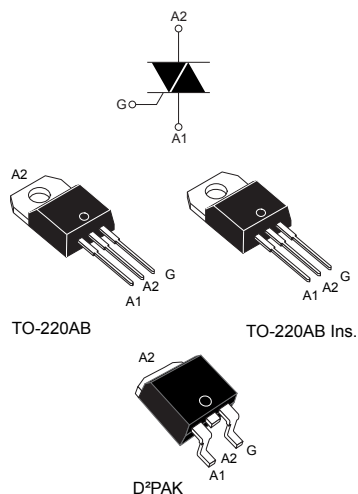


25 A, 1200 V Snubberless Triacs



Features

- On-state RMS current: 25 A
- Blocking voltage: 1200 V
- High static community and dynamic commutation
- $I_{GT} = 50$ mA
- High endurance reliability
- Compact high voltage device
- UL recognized component : UL1557 standard, reference file E81734

Applications

- Motor control circuits
- Heating control circuits

Description

The T2550-12x is a 25 A 1200 V Snubberless Triac available in three packages: D²PAK, TO-220AB and TO-220AB insulated.

Its 1200 V blocking voltage enables use in 3-phase industrial application. Its noise immunity and dynamic commutation makes it suitable for either inductive, capacitive or resistive load control.

Product status link

[T2550-12G, T2550-12T, T2550-12I](#)

Product summary

$I_{T(RMS)}$	25 A
V_{DRM}/V_{RRM}	1200 V
I_{GT}	50 mA

1 Characteristics

Table 1. Absolute maximum ratings (limiting values, $T_j = 25\text{ °C}$, unless otherwise stated)

Symbol	Parameters			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	D ² PAK, TO-220AB	$T_c = 100\text{ }^{\circ}\text{C}$	25	A
		TO-220AB Ins.	$T_c = 71\text{ }^{\circ}\text{C}$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = $25\text{ }^{\circ}\text{C}$)	$t_p = 20\text{ ms}$		240	A
		$t_p = 16.7\text{ ms}$		252	
I^2t	I^2t value for fusing	$t_p = 10\text{ ms}$		380	A^2s
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ ns}$	$f = 60\text{ Hz}$	$T_j = 125\text{ }^{\circ}\text{C}$	100	$\text{A}/\mu\text{s}$
V_{DRM}/V_{RRM}	Repetitive peak off-state voltage			1200	V
V_{DSM}/V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10\text{ ms}$		1300	V
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu\text{s}$		4	A
V_{GM}	Peak positive gate voltage	$t_p = 20\text{ }\mu\text{s}$		16	V
$P_{G(AV)}$	Average gate power dissipation			1	W
T_{stg}	Storage junction temperature range			-40 to +150	$^{\circ}\text{C}$
T_j	Operating junction temperature range			-40 to +125	$^{\circ}\text{C}$
$V_{ins.}$	Insulation RMS voltage, 1 minute	TO-220AB Ins.		2500	V

Table 2. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified) - Snubberless™ (3 quadrants)

Symbol	Parameters	Quadrant		Value	Unit
I_{GT}	$V_D = 12\text{ V}$, $R_L = 33\text{ }\Omega$	I - II - III	Min.	2.5	mA
			Max.	50	
V_{GT}		I - II - III	Max.	1.3	V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3\text{ k}\Omega$, $T_j = 125\text{ °C}$	I - II - III	Min.	0.2	V
$I_{H(1)}$	$I_T = 500\text{ mA}$, gate open		Max.	60	mA
I_L	$I_G = 1.2 I_{GT}$	I - II - III	Max.	80	mA
$dV/dt^{(1)}$	$V_D = 67\text{ }\%$ V_{DRM} gate open, $T_j = 125\text{ °C}$		Min.	2500	$V/\mu s$
$(di/dt)^{(1)}$	Without snubber, $T_j = 125\text{ °C}$		Min.	20	A/ms
t_{gt}	$I_{TM} = 13\text{ A}$, $V_D = 400\text{ V}$, $I_G = 100\text{ mA}$, $di_G/dt = 100\text{ mA}/\mu s$, $R_L = 30\text{ }\Omega$	I - II - III	Typ.	2	μs

1. For both polarities of A2 referenced to A1

Table 3. Static electrical characteristics

Symbol	Test conditions	T _j		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 35 A, t _p = 380 μs	25 °C	Max.	1.55	V
V _{TO} ⁽¹⁾	threshold on-state voltage	125 °C	Max.	0.85	V
R _D ⁽¹⁾	Dynamic resistance	125 °C	Max.	20	mΩ
I _{DRM} I _{RRM}	V _D = V _R = 1200 V	25 °C	Max.	10	μA
		125 °C		6	mA

1. For both polarities of A2 referenced to A1

Table 4. Thermal resistance

Symbol	Parameters			Value	Unit
R _{th(j-c)}	Junction to case (AC)	TO-220AB / D ² PAK	Max.	0.8	°C/W
		TO-220AB insulated		1.7	
R _{th(j-a)}	Junction to ambient (S = 2 cm ²) ⁽¹⁾	D ² PAK	Typ.	45	
	Junction to ambient	TO-220AB / TO-220AB ins		60	

1. Copper surface under tab.

1.1 Characteristics (curves)

Figure 1. Maximum power dissipation versus on-state RMS current (full cycle)

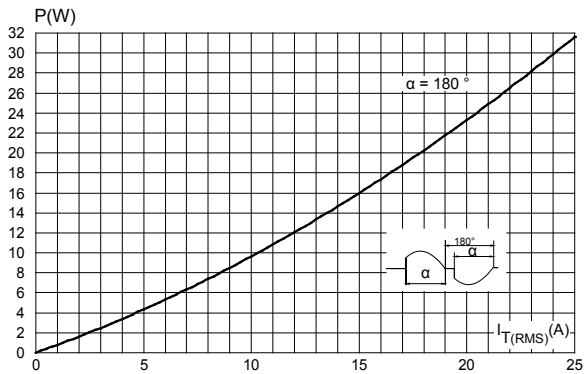


Figure 2. RMS on-state current versus case temperature (full cycle)

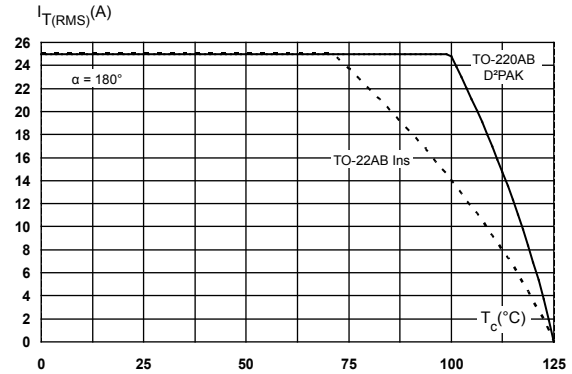


Figure 3. On-state RMS current versus ambient temperature (free air convection)

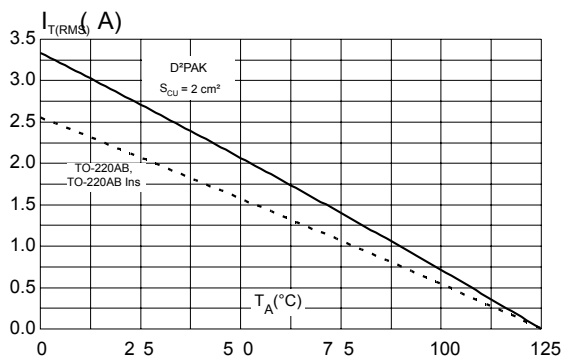


Figure 4. Surge peak on-state current versus number of cycles

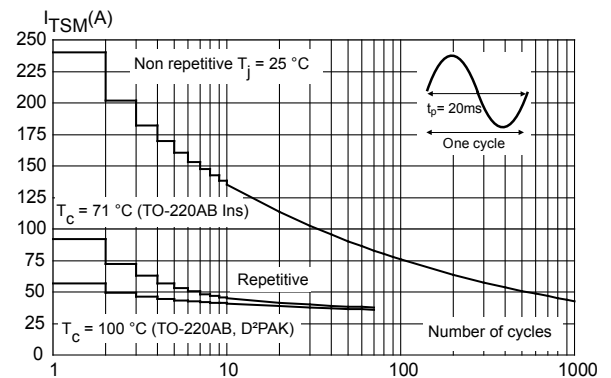


Figure 5. Relative variation of thermal impedance versus pulse duration (T2550-12I)

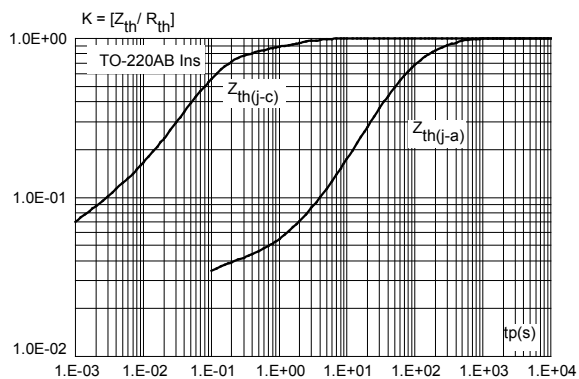


Figure 6. Relative variation of thermal impedance versus pulse duration

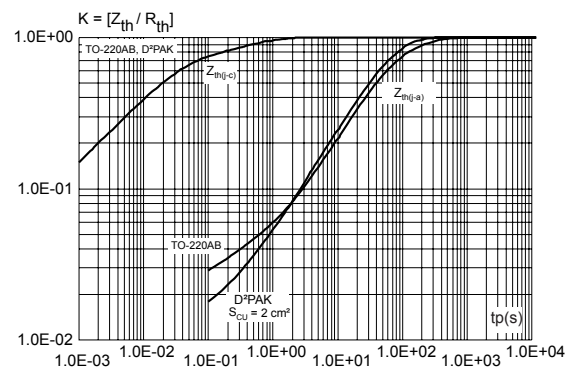


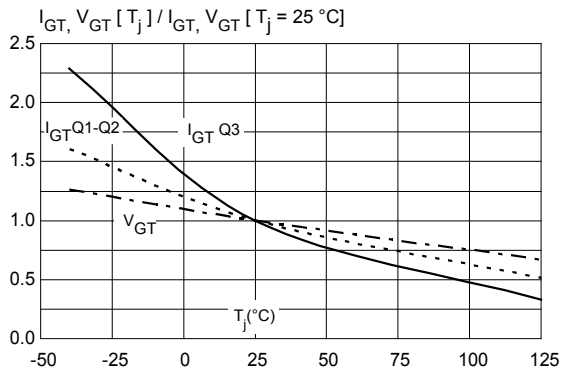
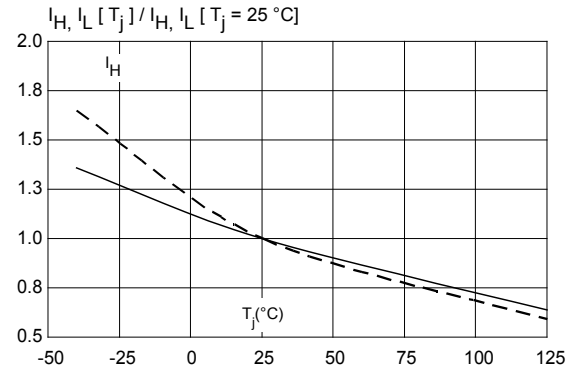
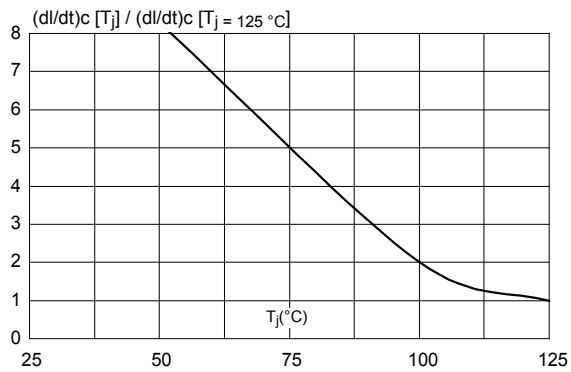
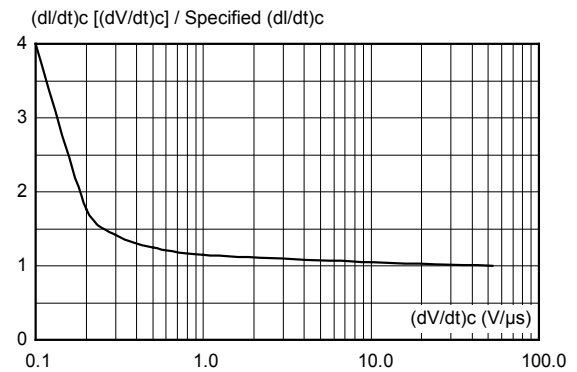
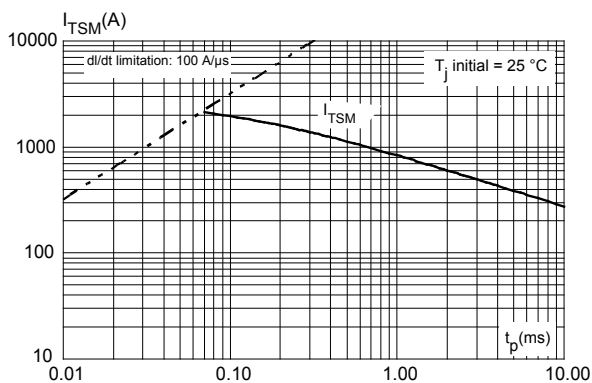
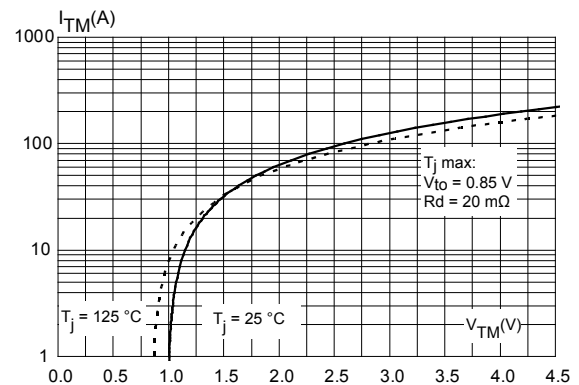
Figure 7. Relative variation of gate trigger current and gate voltage versus junction temperature (typical values)

Figure 8. Relative variation of holding current and latching current versus junction temperature (typical values)

Figure 9. Relative variation of critical rate of decrease of main current versus junction temperature (typical values)

Figure 10. Relative variation of critical rate of decrease of main current versus reapplied dV/dt

Figure 11. Non repetitive surge peak on-state current versus sinusoidal pulse width ($t_p < 10$ ms)

Figure 12. On-state characteristics (maximum values)


Figure 13. Relative variation of leakage current versus junction temperature for different values of blocking voltage (typical values)

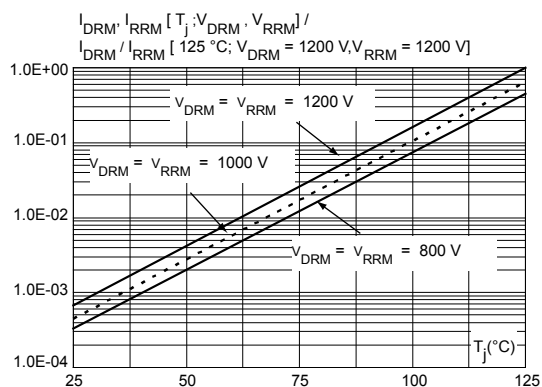
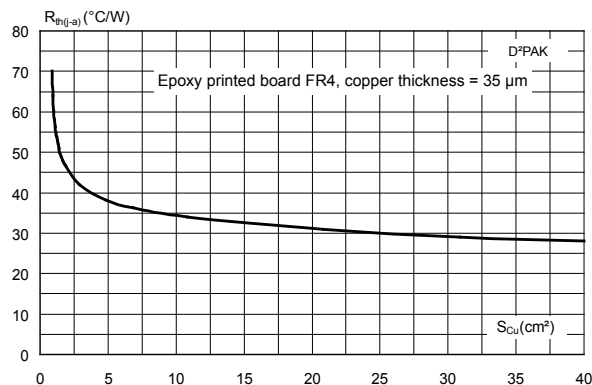


Figure 14. D²PAK thermal resistance junction to ambient versus copper surface under tab



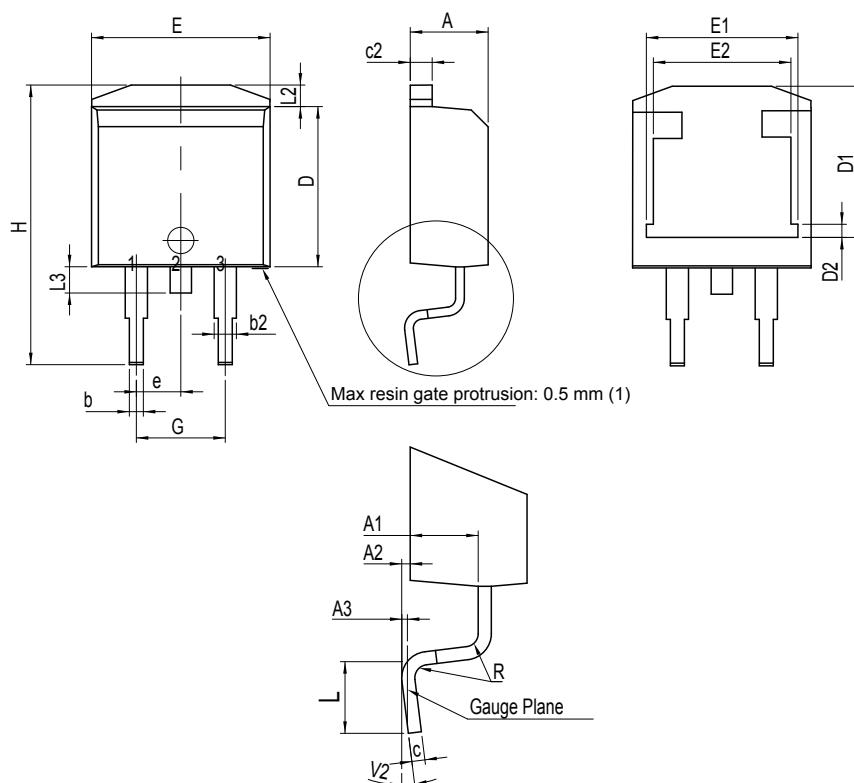
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

- Molding epoxy meets UL94 level V0
- lead-free plating of package leads

Figure 15. D²PAK package outline



(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

Table 5. D²PAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
c	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
e	2.54			0.1		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
H	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0500		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2	0°		8°	0°		8°

1. Dimensions in inches are given for reference only

Figure 16. D²PAK recommended footprint (dimensions are in mm)

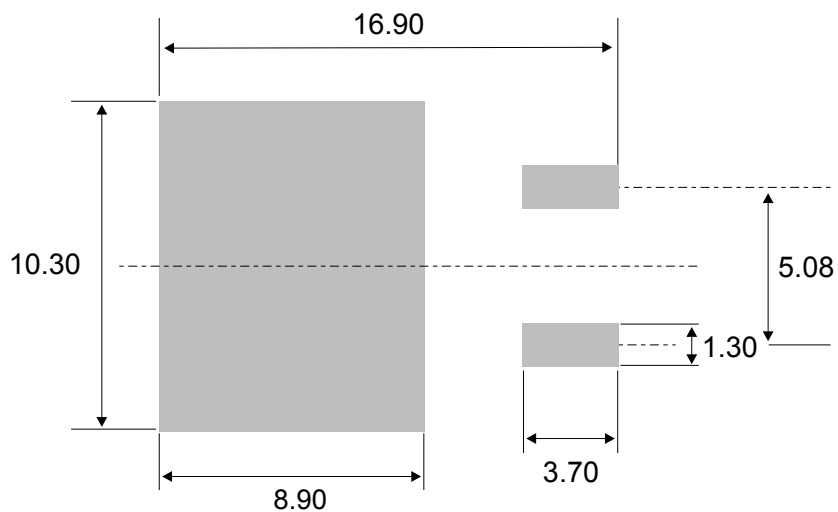
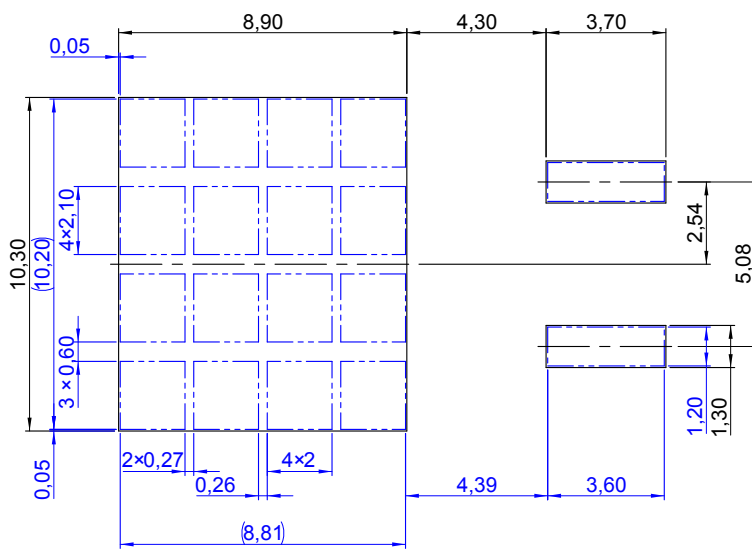


Figure 17. D²PAK footprint and stencil dimensions' definitions (dimensions in mm)

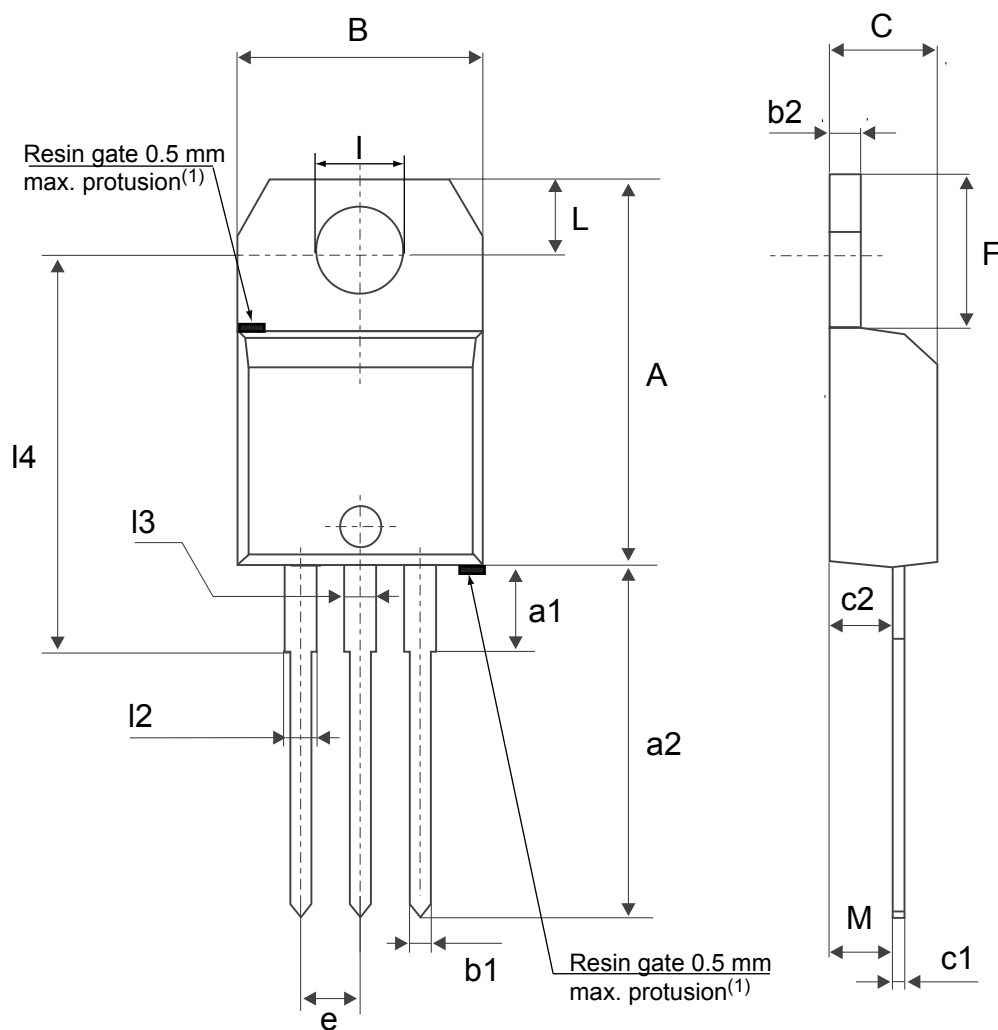


Note: Blue = Stencil, Black = Footprint

2.2 TO-220AB non ins. and insulated package information

- Molding compound resin is halogen-free and meets flammability standard UL94 level 0
- Lead-free package leads finishing
- Recommended torque: 0.4 to 0.6 N.m

Figure 18. TO-220AB non ins. and insulated package outline



(1) Resin gate position accepted in one of the two positions or in the symmetrical opposites.

Table 6. TO-220AB non ins. and insulated package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ¹		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
B	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
C	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
e	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
I2	1.14		1.70	0.0449		0.0669
I3	1.14		1.70	0.0449		0.0669
I4	15.80	16.40	16.80	0.6220	0.6457	0.6614
M		2.6			0.1024	

1. Inch dimensions are for reference only.

3 Ordering information

Figure 19. Ordering information scheme

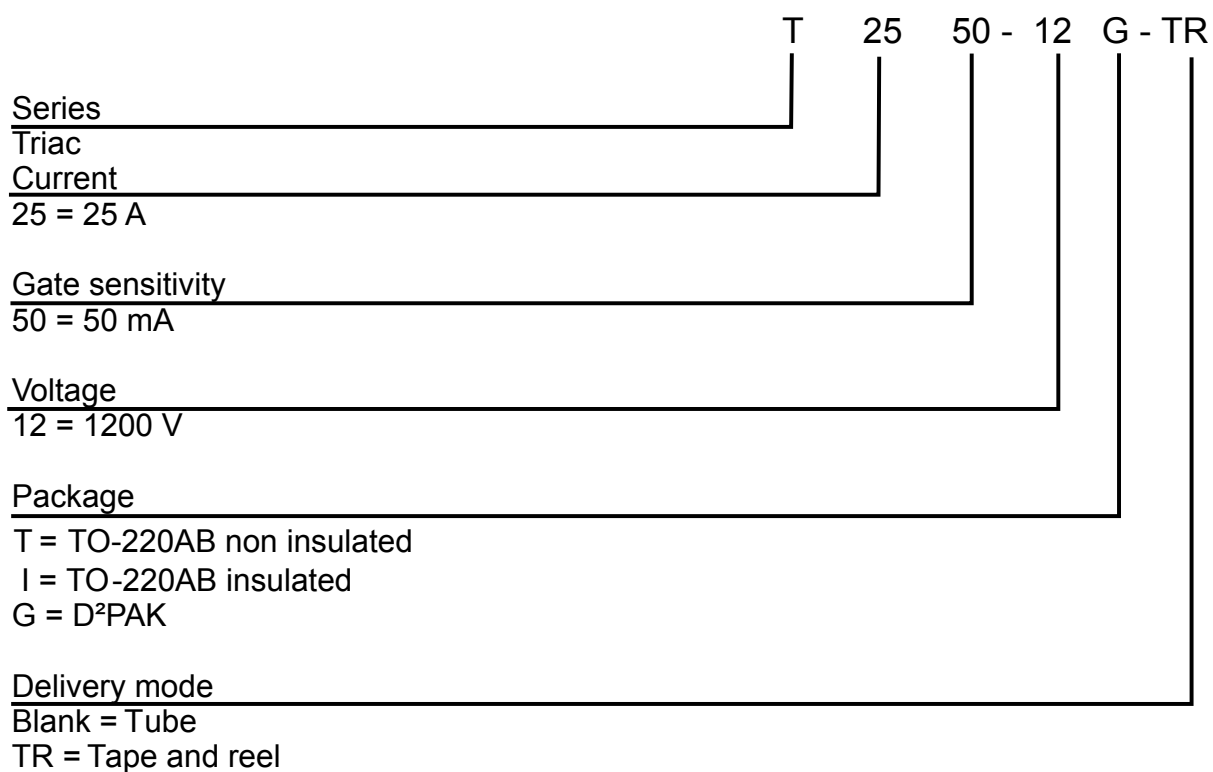


Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T2550-12G	T2550-12G	D ² PAK	1.50 g	50	Tube
T2550-12G-TR				1000	Tape and reel 13"
T2550-12T	T2550-12T	TO-220AB	2.3 g	50	Tube
T2550-12I	T2550-12	TO-220AB Ins.	2.3 g	50	Tube

Revision history

Table 8. Document revision history

Date	Revision	Changes
9-Jan-2014	1	Initial release.
30-Jan-2014	2	Updated table 4.
10-Dec-2015	3	Inserted TO-220AB insulated package information and reformatted to current standard.
17-May-2019	4	Updated Table 1, Table 4 and Figure 15. Added Figure 18. Minor text changed.
23-Sep-2020	5	Updated Section Features and Table 5. D²PAK package mechanical data .

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